SPECIFICATION FOR YOLDAL CHIP LED

PART. NO: UBSM1206WL363

YOLDAL



Features:

- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase re-flow solder process.
- Mono-color type.

Descriptions:

- Much smaller than lead frame type components, enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Lightweight for miniature applications.

Applications:

- Model Railroad and Auto Headlights
- Backlighting
- Indicators
- Switch and symbol
- ➢ General use

Benefits:

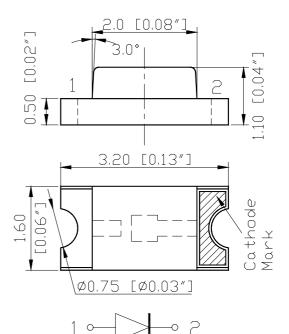
- Low Energy Consumptions
- Low Maintenance Costs
- High Application Design Flexibility
- High Reliability
- Very Competitive prices

Device material descriptions:

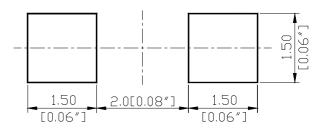
Part ID	Chip		Lens Color	
UBSM1206WL363	Material	Emitted Color	Yellow	
	InGaN		Diffused	

Package Outline Dimensions:





Recommend Pad Layout



Notes: Tolerances Unless Dimensions, 0.1mm,Angles $\pm 0.5^{\circ}$, Unit: mm



Absolute maximum ratings:

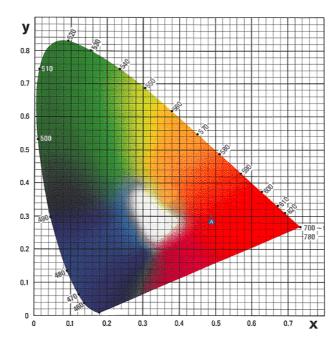
Parameter	Symbol	Rating	Unit V	
Reverse Voltage	V _R	5		
Forward Current	I _F 20		mA	
Operating temperature	Topr	-25 ~ +80	°C	
Storage Temperature	Tstg	-30 ~ +85	°C	
Soldering temperature	Tsol	260 (for 5 Second)	°C	
Power Dissipation	Pd	80	mW	
Electrostatic Discharge*	ESD	150	V	
Peak Forward Current	I	400	mA	
(Duty 1/10 @1KHz)	IPF	100		

*Static Electricity Sensitive, care must be fully taken when handling this product.

Electro-Optical characteristics:

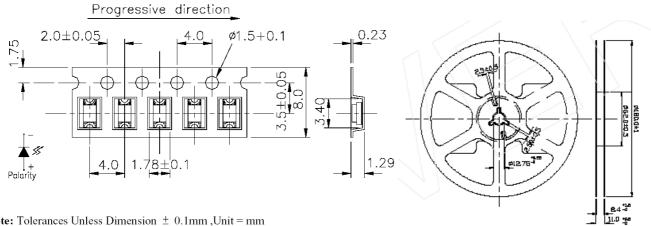
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv		550		mcd	I _F =20 mA
Viewing angle	2 <i>θ</i> 1/2		120		Deg.	I _F =20 mA
Forward Voltage	V _F		3.2	3.7	V	I _F =20 mA
Reverse Current	I _R			50	uA	V _R =5V
Chromaticity*	Х		0.31			$I_F=20 \text{ mA}$
Coordinate	Y		0.32			$I_{\rm F}$ =20 IIIA

*C.I.E. 1931 Chromaticity Diagram.





Taping Dimensions: 3000 pieces per reel.



Note: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

Reliability Test and Condition:

ltem	Test Condition	Test	Sampling	Failure	Ac/Rc
		Hour/Cycle	pcs.	Judgment	
Reflow	Temp.: 240 °C±5°C	6 min.	30		0/1
	Min. 5 Second	0 mm.			0/1
	H: +85 °C, 30 min.			$I_R \geqq U \; x \; 1.0$	
Temperature Cycle	∫ 5 min.	50 cycles	30	$I_V \ge \! L x \; 0.5$	0/1
	L: -55 °C, 30 Min.			$V_F \ge \! U \; x \; 1.2$	
	H: +100 °C, 5 min.				
Thermal Shock	∫ 10 Sec.	50 cycles	30	U: Upper	0/1
	L: -10 °C, 5 Min.			specification	
High Temperature	+100 °C	1000 hrs.	30	limited	0/1
Storage	+100 C				0/1
Low Temperature	FF ⁰ 0	1000 has	30	L: Lower	0/4
Storage	-55 °C	1000 hrs.		specification	0/1
DC Operating Life	I _F =20mA	1000 hrs.	30	limited	0/1
High		1000 hm	20		0/1
Temperature/Humidity	+85 °C / R.H. 85%	1000 hrs.	30		0/1

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Precautions For Use

Innovation Power

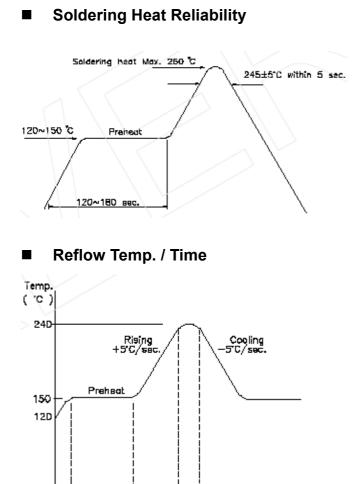
1. Over Current Proof

Resistors must properly applied for protection, slightly voltage shift will cause big current change, BURN OUT will happen.

2. Storage Time

YOLDAL

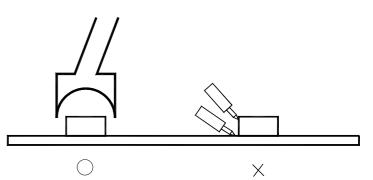
- 2.1. The operating temperature and RH: $5 \degree C \sim 35 \degree C$, RH60%.
- 2.2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with desiccating agent. Taping life considering, strongly suggest using this products within one year from date of production.
- 2.3. Package opened more than one week in an normal atmosphere environment, before soldering, they should be treated at $60 \,^{\circ}\text{C} \pm 5 \,^{\circ}\text{C}$ for 15 hrs.
- 2.4. When the desiccant agent changed to pink, the device should be treated as condition 2.3.



5 sec

Rework

- Rework must be finished within 5 sec. under 245 °C.
- 2. The head of Iron must not touch the copper foil.
- 3. Twin-head type is preferred.



Soldering Iron

Basic spec is $\leq 5 \text{ sec.} / 260 \,^{\circ}\text{C.}$ If temperature is higher, time should be shorted (+10 $^{\circ}\text{C} \rightarrow$ -1 sec.). Power dissipation of Iron should be smaller than 15 W, and temperature should be controllable. Surface temperature of the device should be under than 230 $^{\circ}\text{C.}$

60~120 sec

Time